| PCN Number: | | 201609200 | 20160920006 PCN Date: | | | Sept. 23, 2016 | | |
|---|--|-----------------|------------------------------|-----------------------------|-------|--------------------|------------------|--|
| Title: Datasheet for | | for SN65DP149 | r SN65DP149 and SN75DP149 | | | | | |
| Cust | omer Contact: | PCN Manager | | | De | pt: | Quality Services | |
| Chan | ge Type: | | | | | | | |
| | Assembly Site | | | Design | | Wafe | r Bump Site | |
| | Assembly Proce | SS | \square | Data Sheet | | | r Bump Material | |
| Assembly Materials | | ials | | Part number change | | Wafer Bump Process | | |
| | Mechanical Spe | cification | | Test Site | | Wafe | r Fab Site | |
| Packing/Shipping/Labeling | | g/Labeling | | Test Process | | Wafe | r Fab Materials | |
| | | | | | | Wafe | r Fab Process | |
| Notification Details | | | | | | | | |
| Description of Change: | | | | | | | | |
| Texas Instruments Incorporated is announcing an information only notification etc. | | | | | | | | |
| | | | | | | | | |
| The product datasheet(s) is being updated as summarized below. | | | | | | | | |
| The following change history provides further details. | | | | | | | | |
| men | Showing change h | istory provides | Tui | ther details. | | | | |
| | | | | | | | | |
| TEXAS INSTRUMENTS SN65DP149, SN75DP149 SLLSEL2C - SEPTEMBER 2015 - REVISED JULY 2016 | | | | | | | | |
| | | | | 31131120- | | VIDEIX 2013 | | |
| Changes from Revision B (April 2016) to Revision C Page | | | | | | | | |
| | | | | | | | | |
| | Recommended Operating Conditions, Changed the CONTROL PINS section | | | | | | | |
| • (| Changed the DDC, and I ² C Electrical Characteristics table | | | | | | | |
| | | | | | | | | |
| The datasheet number will be changing. | | | | | | | | |
| Device Family | | | Change From: | | | Change To: | | |
| SN65DP149 and SN75DP1 | | DP149 | | | | SLLSEL2C | | |
| | | | | | | | | |
| These | e changes may be | reviewed at the | e d | atasheet links provided. | | | | |
| | //www.ti.com/pro | | | P | | | | |
| Reason for Change: | | | | | | | | |
| | ore accurately ref | ect device char | act | eristics. | | | | |
| | , | | | ction, Quality or Reliabili | ity (| nositi | ve / negative): | |
| | | | | | | | | |
| No anticipated impact. This is a specification change announcement only. There are no changes to the actual device. | | | | | | | | |
| | | | | | | | | |
| Changes to product identification resulting from this PCN: | | | | | | | | |
| None. | | | | | | | | |
| Product Affected: | | | | | | | | |
| SN6 | 5DP149RSBR | SN65DP149 | RS | BT SN75DP149RSBR | | SN75 | DP149RSBT | |
| | | · | | • | | | | |
| For questions regarding this notice, e-mails can be sent to the regional contacts shown below | | | | | | | | |
| or vour local Field Sales Representative. | | | | | | | | |

| Location | E-Mail |
|--------------|--------------------------------|
| USA | PCNAmericasContact@list.ti.com |
| Europe | PCNEuropeContact@list.ti.com |
| Asia Pacific | PCNAsiaContact@list.ti.com |
| Japan | PCNJapanContact@list.ti.com |